Varistor Datasheet

MLA Varistor Series Surface Mount Multilayer Varistors (MLVs)

RoHS



Additional Information





Resources

Accessories

Samples

Size Table

Metric	EIA
1005	0402
1608	0603
2012	0805
3216	1206
3225	1210

Absolute Maximum Ratings

• For ratings of individual members of a series, see device ratings and specifications table.

Continuous	ML Series	Units
Steady State Applied Voltage		
DC Voltage Range (V _{M(DC)})	3.5 to 120	V
AC Voltage Range (V _{M(AC)RMS})	2.5 to 107	V
Transient		
Non-Repetitive Surge Current, 8/20µs Waveform, (I _{TM})	4 to 500	А
Non-Repetitive Surge Energy, 10/1000 μs Waveform, (W_TM)	0.02 to 2.5	J
Operating Ambient Temperature Range (T_{A})	-40 to +125	°C
Storage Temperature Range (T_{STG})	-40 to +150	°C
Temperature Coefficient (aV) of Clamping Voltage (V_c) at Specified Test Current	<0.01	%/°C

Description

The MLA Series family of transient voltage surge suppression devices is based on the Littelfuse Multilayer fabrication technology. These components are designed to suppress a variety of transient events, including those specified in IEC 61000-4-2 or other standards used for Electromagnetic Compliance (EMC). The MLA Series is typically applied to protect integrated circuits and other components at the circuit board level.

The wide operating voltage and energy range make the MLA Series suitable for numerous applications on power supply, control and signal lines.

The MLA Series is manufactured from semiconducting ceramics, and is supplied in a leadless, surface mount package. The MLA Series is compatible with modern reflow and wave soldering procedures.

It can operate over a wider temperature range than Zener diodes, and has a much smaller footprint than plastic-housed components. Littelfuse Inc. manufactures other multilayer series products. See the MLE Series data sheet for ESD applications, MHS Series data sheet for high-speed ESD applications, the MLN Series for multiline protection and the AUML Series for automotive applications.

Features

- Halogen-Free and RoHS compliant
- Leadless 0402, 0603, 0805, 1206 and 1210 chip sizes
- Multilayer ceramic construction technology
- -40°C to +125°C operating temp. range
- Operating voltage range VM(DC) = 3.5V to 120v

Applications

- Suppression of inductive switching or other transient events such as EFT and surge voltage at the circuit board level
- ESD protection for IEC 61000-4-2, MIL-STD-883 method 3015.7, and other industry specifications (see also the MLE or MLN Series)

- Rated for surge current (8 x 20µs)
- Rated for energy (10 x 1000µs)
- Inherent bi-directional clamping
- Standard low capacitance types available
- Provides on-board transient voltage protection for ICS and transistors
- Used to help achieve electromagnetic compliance of end products
- Replace larger surface mount TVS Zeners in many applications



Device Ratings and Specifications

		Maximum Ratings (125°C)			Specifications (25°C)					
Part Number		Continuous y Voltage	Maximum Non- repetitive Surge Current (8/20µs)	Maximum Non- repetitive Surge Energy(10/1000µs)	Maximum Clamping Voltage(8/20µs		Nominal Voltage Tes Current@ 1mA DC		t Typical Capacitance@ 1MHz	
	VM (DC)	VM (AC)	I _{TM}	WTM	V _c	I _{PK}	VN (DC)	VN (DC)	С	
	(V)	(V)	(A)	(J)	v	Α	Min (V)	Max (V)	(pF)	
V3.5MLA0603N⁵	3,5	2,5	30	0,1	13	1	3.7	7.0	1270	
V3.5MLA0805N	3,5	2,5	60	0,3	13	1	3.7	7.0	1760	
V3.5MLA0805LN	3,5	2,5	40	0,1	13	1	3.7	7.0	1380	
V3.5MLA1206N	3,5	2,5	100	0,3	13	1	3.7	7.0	5800	
V5.5MLA0402N ⁸	5,5	4	20	0,05	21	1	7.1	10.8	220	
V5.5MLA0402LN ⁸	5,5	4	20	0,05	39	1	15.9	21.5	70	
V5.5MLA0603N5	5,5	4	30	0,1	17,5	1	7.1	9.3	960	
V5.5MLA0603LN4	5,5	4	30	0,1	17,5	1	7.1	9.3	450	
V5.5MLA0805N	5,5	4	120	0,3	17,5	1	7.1	9.3	1200	
V5.5MLA0805LN	5,5	4	40	0,1	17,5	1	7.1	9.3	660	
V5.5MLA0805NS ¹⁰	5,5	4	80	0,1	20	1	7,5	10,5	1400	
V5.5MLA1206N	5,5	4	150	0,4	17,5	1	7.1	9.3	2800	
V5.5MLA1206NS ¹⁰	5,5	4	100	0,2	20	1	7,5	10,5	3100	
V5.5MLA1210NS ¹⁰	5,5	4	250	0,4	20	2,5	7,5	10,5	5200	
V9MLA0402N ⁸	9	6,5	20	0,05	30	1	11.0	16.0	120	
V9MLA0402LN ⁸	9	6,5	4	0,02	35	1	11.0	16.0	33	
V9MLA0603N ^{5 8}	9	6,5	30	0,1	25.5	1	11.0	16	490	
V9MLA0603LN ^{4 8}	9	6,5	30	0,1	25.5	1	11.0	16	360	
V9MLA0805LN ⁸	9	6,5	40	0,1	25,5	1	11.0	16.0	320	
V9MLA0805NS ¹⁰	9	6	80	0,1	24	1	10,2	13,8	650	
V12MLA0805LN ⁸	12	9	40	0,1	29	1	14.0	18.5	220	
V14MLA0402N ⁸	14	10	20	0,05	39	1	15.9	21.5	70	
V14MLA0603N ⁸	14	10	30	0,1	34,5	1	15.9	21.5	180	
V14MLA0805N ⁸	14	10	120	0,3	32	1	15.9	20.3	360	
V14MLA0805LN ⁸	14	10	40	0,1	32	1	15.9	20.3	200	
V14MLA0805NS ¹⁰	14	11	100	0,1	30	1	15,3	20,7	350	
V14MLA1206N ⁸	14	10	150	0,4	32	1	15.9	20.3	800	
V14MLA1206NS ¹⁰	14	11	200	0,5	30	1	15,3	20,7	1200	
V18MLA0402N ⁸	18	14	20	0,05	50	1	22.0	28.0	40	
V18MLA0603N ⁸	18	14	30	0,1	50	1	22.0	28.0	120	
V18MLA0805N ⁸	18	14	120	0,3	44	1	22.0	28.0	260	
V18MLA0805LN ⁸	18	14	40	0,1	44	1	22.0	28.0	170	
V18MLA0805NS ¹⁰	18	14	100	0,2	39	1	21,6	26,4	300	
V18MLA1206N ⁸	18	14	150	0,4	44	1	22.0	28.0	1030	
V18MLA1206NS ¹⁰	18	14	200	0,5	39	1	21,6	26,4	780	
V18MLA1210N ⁸	18	14	500	2,5	44	2,5	22	28	2500	
V18MLA1210NS ¹⁰	18	14	400	1,4	39	2,5	21,6	26,4	1600	
V18MLA1812N ^{7 8}	18	14	1000	2,9	44	5	21,0	28	4050	
V22MLA0805NS ¹⁰	22	14	1000	0,2	44	1	24,3	29,7	250	
V22MLA1206NS ¹⁰	22	17	100	0,2	44	1	24,3	29,7	700	
V22MLA1210NS ¹⁰	22	17	400	1,7	44	2,5	24,3	29,7	1500	
V26MLA0603N ⁸	26	20	30	0,1	60	2,5	31.0	38.0	110	
V26MLA0805N ⁸	26	20	100	0,3	60	1	29.5	38.5	110	
V26MLA0805LN ⁸	20	20	40	0,3	60	1	29.5	38.5	90	
V26MLA0805NS ¹⁰	26	20	100	0,1	54	1	29.5	36,3	220	
V26MLA1206N ⁸	20	20	150	0,6	60	1	29,7	38.5	630	

Device Ratings and Specifications (Continue...)

			Specifications (25°C)							
Part Number	Maximum Continuous Working Voltage		Maximum Non- repetitive Surge Current (8/20µs)	Maximum Non- repetitive Surge Energy(10/1000µs)	Maximum Clamping Voltage(8/20µs)		Nominal Voltage Test Current@ 1mA DC		Typical Capacitance@ 1MHz	
	VM (DC)	VM (AC)	I _{TM}	WTM	V _c I _{PK}		VN (DC) VN (DC)		С	
	(V)	(V)	(A)	(J)	v	А	Min (V)	Max (V)	(pF)	
V26MLA1206NS10	26	20	200	0,7	54	1	29,7	36,3	700	
V26MLA1210N8	26	20	300	1,2	60	2,5	29,5	38,5	1250	
V26MLA1210NS10	26	20	400	1,9	54	2,5	29,7	36,3	880	
V30MLA0603N8	30	25	30	0,1	74	1	37.0	46.0	90	
V30MLA0805LN ⁸	30	25	30	0,1	72	1	37.0	46.0	85	
V30MLA0805NS10	30	25	100	0,3	65	1	35,1	42,9	200	
V30MLA1206N8	30	25	180	1	67	1	35.0	43.0	400	
V30MLA1206NS10	30	25	200	1	65	1	35,1	42,9	510	
V30MLA1210N8	30	25	280	1,2	68	2,5	35	43	685	
V30MLA1210LN ⁸	30	25	220	0,9	68	2,5	35	43	500	
V30MLA1210NS10	30	25	400	1,7	65	2,5	35,1	42,9	800	
V30MLA1812N78	30	25	800	3,7	65	5	35	43	1900	
V33MLA1206N8	33	26	180	0,8	75	1	38.0	49.0	390	
V38MLA0805NS10	38	30	100	0,3	77	1	42,3	51,7	150	
V38MLA1206NS10	38	30	200	1,1	77	1	42,3	51,7	440	
V38MLA1210NS10	38	30	400	2	77	2,5	42,3	51,7	530	
V38MLA1812N78	38	30	800	4,5	77	5	43	52	1450	
V42MLA1206N8	42	30	180	0,8	92	1	46.0	60.0	345	
V45MLA0805NS10	45	35	80	0,3	90	1	50,4	61,6	110	
V45MLA1206NS10	45	35	100	0,8	90	1	50,4	61,6	230	
V45MLA1210NS10	45	35	250	2	90	2,5	50,4	61,6	400	
V45MLA1812N78	45	35	500	4	90	5	50,4	61,6	1200	
V48MLA1206N ⁸	48	40	180	0,9	100	1	54.5	66.5	185	
V48MLA1210N ⁸	48	40	250	1,2	105	2,5	54,5	66,5	400	
V48MLA1210LN ⁸	48	40	220	0,9	105	2,5	54,5	66,5	380	
V56MLA1206N ⁸	56	40	180	1	120	1	61.0	77.0	180	
V56MLA1206NS ¹⁰	56	40	100	1	110	1	61,2	74,8	200	
V56MLA1210NS ¹⁰	56	40	250	2,3	110	2,5	61,2	74,8	300	
V60MLA1210N ⁸	60	50	250	1,5	130	2,5	67	83	230	
V65MLA1206NS ¹⁰	65	50	100	0,5	135	1	73,8	90,2	175	
V68MLA1206N ⁸	68	50	180	1	140	1	76	90	130	
V85MLA1206NS ¹⁰	85	60	100	0.6	165	1	90	110	150	
V85MLA1210N ⁸	85	67	250	2,5	180	2,5	95	115	160	
V120MLA1210N ⁸	120	107	125	2	260	2,5	135	165	70	

Notes:

1. 'L' suffix is a low capacitance and energy version; Contact your Littelfuse sales representative for custom capacitance requirements.

L Sum X is a low capacitatice and energy version, contact your Litteriuse sales representative for custom capacitatice requirements.
Typical leakage at 25°C-25µA, maximum leakage 100µA at V_{MDC7} to 0402 size, typical leakage <5µA, maximum leakage <20µA at V_{MDC7}.
Average power dissipation of transients for 0402, 0600, 0805, 1206 and 1210 sizes not to exceed 0.03W, 0.05W, 0.1W, 0.1W and 0.15W respectively.
Item is available as 'R' packing option only. All 0402 size items available as 'R' packaging option only. See Packaging section for additional information.
Item is available in 'H', Tand 'A' packing option only. All 0805, 1206 and 1210 parts come as 'H', Tand 'A' packing option only. See Packaging section for additional information.

The typical capacitance rating is the discrete component test result.
Item is available in "T" packing option only.
ESD rated to IEC61000-4-2 level 4: air discharge 15KV, contact 8KV

9. ESD higher rating than IEC61000-4-2(level 4), please contact littelfuse

10. "NS" suffix parts are only -40'C to 85'C operating ambient temperature range

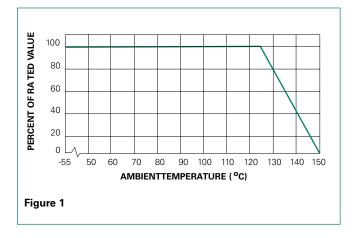


Varistor Datasheet

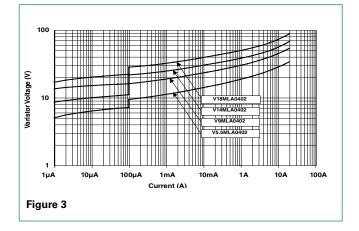
MLA Varistor Series Surface Mount Multilayer Varistors (MLVs)

Peak Current and Energy Derating Curve

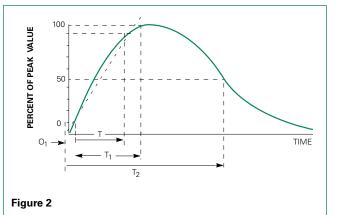
When transients occur in rapid succession, the average power dissipation is the energy (watt-seconds) per pulse times the number of pulses per second. The power so developed must be within the specifications shown on the Device Ratings and Specifications Table for the specific device. For applications exceeding 125°C ambient temperature, the peak surge current and energy ratings must be derated as shown below.



Limit V-I Characteristic for V5.5MLA0402 to V18MLA0402



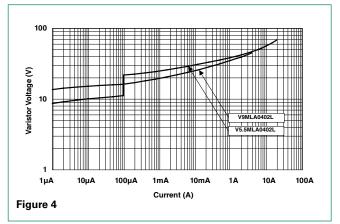
Peak Pulse Current Test Waveform for Clamping Voltage

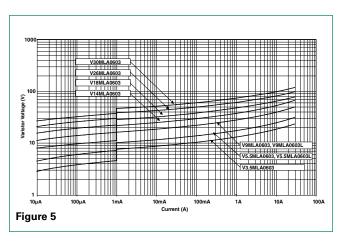


0, = Virtual Origin of Wave

- T = Time from 10% to 90% of Peak
- $T_1 = Rise Time = 1.25 \times T$
- $T_2 = Decay Time$
- **Example** For an 8/20 μ s Current Waveform: 8 μ s = T, = Rise Time
 - $20\mu s = T_2 = Decay Time$

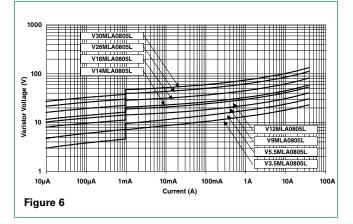
Limit V-I Characteristic for V9MLA0402L



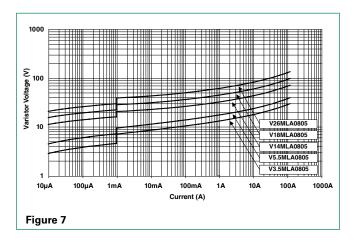


Limit V-I Characteristic for V3.5MLA0603 to V30MLA0603

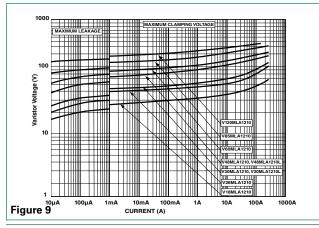
Limit V-I Characteristic for V3.5MLA0805L to V30MLA0805L



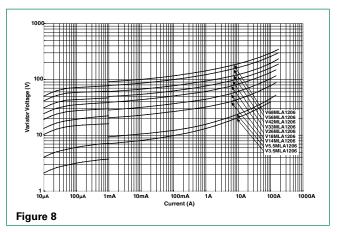
Limit V-I Characteristic for V3.5MLA0805 to V26MLA0805



Limit V-I Characteristic for V18MLA1210 to V120MLA1210

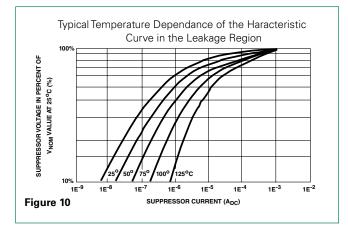


Limit V-I Characteristic for V3.5MLA1206 to V68MLA1206



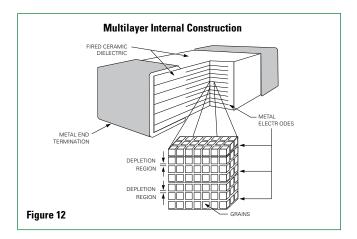
Device Characteristics

At low current levels, the V-I curve of the multilayer transient voltage suppressor approaches a linear (ohmic) relationship and shows a temperature dependent effect. At or below the maximum working voltage, the suppressor is in a high resistance modex (approaching 106Ω at its maximum rated working voltage). Leakage currents at maximum rated voltage are below 100μ A, typically 25μ A; for 0402 size below 20μ A, typically 5μ A.

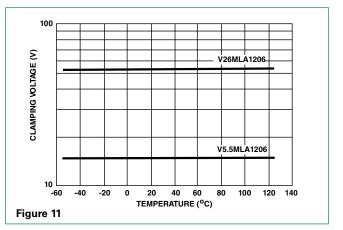


Speed of Response

The Multilayer Suppressor is a leadless device. Its response time is not limited by the parasitic lead inductances found in other surface mount packages. The response time of the ZNO dielectric material is less than 1ns and the MLA can clamp very fast dV/dT events such as ESD. Additionally, in "real world" applications, the associated circuit wiring is often the greatest factor effecting speed of response. Therefore, transient suppressor placement within a circuit can be considered important in certain instances.



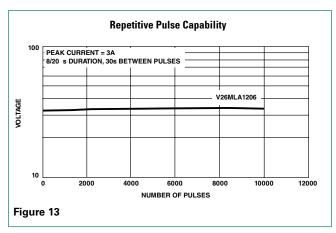
Clamping Voltage Over Temperature (VC at 10A)



Energy Absorption/Peak Current Capability

Energy dissipated within the MLA Series is calculated by multiplying the clamping voltage, transient current and transient duration. An important advantage of the multilayer is its interdigitated electrode construction within the mass of dielectric material. This results in excellent current distribution and the peak temperature per energy absorbed is very low. The matrix of semiconducting grains combine to absorb and distribute transient energy (heat) (see Speed of Response). This dramatically reduces peak temperature; thermal stresses and enhances device reliability.

As a measure of the device capability in energy and peak current handling, the V26MLA1206A part was tested with multiple pulses at its peak current rating (3A, $8/20\mu$ s). At the end of the test,10,000 pulses later, the device voltage characteristics are still well within specification.



Lead (Pb) Soldering Recommendations

The principal techniques used for the soldering of components in surface mount technology are IR Re-flow and Wave soldering. Typical profiles are shown on the right.

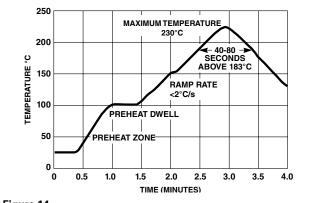
The recommended solder for the MLA suppressor is a 62/36/2 (Sn/Pb/Ag), 60/40 (Sn/Pb) or 63/37 (Sn/Pb). Littelfuse also recommends an RMA solder flux.

Wave soldering is the most strenuous of the processes. To avoid the possibility of generating stresses due to thermal shock, a preheat stage in the soldering process is recommended, and the peak temperature of the solder process should be rigidly controlled.

When using a reflow process, care should be taken to ensure that the MLA chip is not subjected to a thermal gradient steeper than 4 degrees per second; the ideal gradient being 2 degrees per second. During the soldering process, preheating to within 100 degrees of the solder's peak temperature is essential to minimize thermal shock.

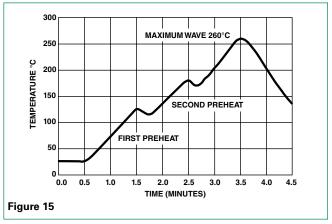
Once the soldering process has been completed, it is still necessary to ensure that any further thermal shocks are avoided. One possible cause of thermal shock is hot printed circuit boards being removed from the solder process and subjected to cleaning solvents at room temperature. The boards must be allowed to cool gradually to less than 50° C before cleaning.

Reflow Solder Profile







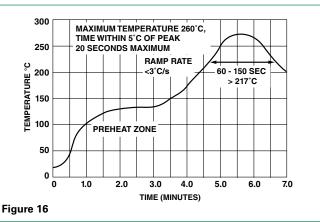


Lead-free (Pb-free) Soldering Recommendations

Littelfuse offers the Nickel Barrier Termination option (see "N" suffix in Part Numbering System for ordering) for the optimum Lead–free solder performance, consisting of a Matte Tin outer surface plated on Nickel underlayer, plated on Silver base metal. The preferred solder is 96.5/3.%.5 (SnAgCu) with an RMA flux, but there is a wide selection of pastes and fluxes available with which the Nickel Barrier parts should be compatible.

The reflow profile must be constrained by the maximums in the Lead–free Reflow Profile. For Lead–free wave soldering, the Wave Solder Profile still applies.

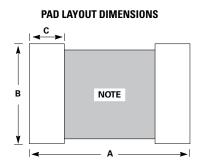
Note: the Lead–free paste, flux and profile were used for evaluation purposes by Littelfuse, based upon industry standards and practices. There are multiple choices of all three available, it is advised that the customer explores the optimum combination for their process as processes vary considerably from site to site.



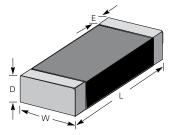
Lead-free Re-flow Solder Profile



Product Dimensions (mm)



CHIP LAYOUT DIMENSIONS



Note: Avoid metal runs in this area, parts not recommended for use in applications using Silver (Ag) epoxy paste.

Dimension	1210) Size	1206 Size		0805 Size		0805 Size		0603 Size		0402 Size	
Dimension	IN	MM	IN	MM	IN	MM	IN	MM	IN	MM		
Α	0.160	4.06	0.160	4.06	0.120	3.05	0.100	2.54	0.067	1.70		
В	0.100	2.54	0.065	1.65	0.050	1.27	0.030	0.76	0.020	0.51		
С	0.040	1.02	0.040	1.02	0.040	1.02	0.035	0.89	0.024	0.61		
D (max.)	0.113	2.87	0.071	1.80	0.043	1.10	0.040	1.00	0.024	0.60		
E	0.020 -/+0.010	0.50 -/+0.25	0.020 -/+0.010	0.50 -/+0.25	0.020 -/+ 0.010	0.50 -/+ 0.25	0.015 -/+0.008	0.4 -/+0.20	0.010 -/+0.006	0.25 -/+0.15		
L	0.125 -/+0.012	3.20 -/+0.30	0.125 -/+0.012	3.20 -/+0.30	0.079 -/+0.008	2.01 -/+0.20	0.063 -/+0.006	1.6 -/+0.15	0.039 -/+0.004	1.00 -/+0.10		
w	0.100 -/+0.012	2.54 -/+0.30	0.060 -/+0.011	1.60 -/+0.28	0.049 -/+0.008	1.25 -/+0.20	0.032 -/+0.060	0.8 -/+0.15	0.020 -/+0.004	0.50 -/+0.10		

Part Numbering System

	<u>v</u>	18	MLA	1206	<u>x</u>	X	X	
DEVICE FAMILY Littelfuse TVS Device								
MAXIMUMDC WORKING VOLTAGE								
MULTILAYER SERIES DESIGNATOR								

0201 = .024 inch x .012 inch (0.6 mm x 0.3 mm) 0402 = .04 inch x .02 inch (1.0 mm x 0.5 mm) 0603 = .063 inch x .031 inch (1.6 mm x 0.8 mm)

- 0805 = .08 inch x .08 inch (2.0 mm x 1.25 mm) 1206 = .126 inch x .063 inch (3.2 mm x 1.6 mm) 1210 = .126 inch x .1 inch (3.2 mm x 2.5 mm)

PACKING OPTIONS (see Packaging table for quantit T: 13in (330mm) Diameter Reel, Plastic Carr H: 7in (178mm) Diameter Reel, Plastic Carri R: 7in (178mm) Diameter Reel, Paper Carrie A: Bulk Pack

END TERMINATION OPTION

N: Nickel Barrier

(Matte Tin outer surface, plated on Nickel underlayer plated on silver base metal)

CAPACITANCE OPTION

No Letter: Standard L: Low Capacitance Version

*Notes:

1/120/LL1210 standard shipping quantities are 1000 pieces per reel for the "H" option and 4000 pieces per reel for "T" option.
2 V3.5 MLA0603, V5.5MLA0603 and V9MLA0603 only available in "H," "T" and "A" packing options.

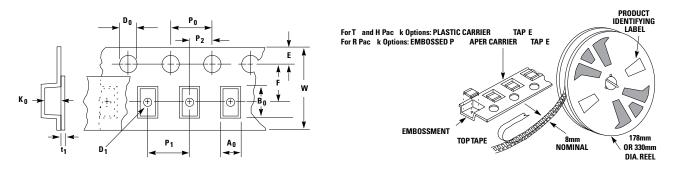
Packaging*

	Quantity								
Device Size	13" Inch Reel ("T" Option)	7″ Inch Reel ("H" Option)	7″ Inch Reel ("R" Option)	Bulk Pack ("A" Option)					
1812	4,000	N/A	N/A	N/A					
1210	8,000	2,000	N/A	2,000					
1206	10,000	2,500	N/A	2,500					
0805	10,000	2,500	N/A	2,500					
0603	10,000	2,500	4,000	2,500					
0402	N/A	N/A	10,000	N/A					

*(Packaging) It is recommended that parts be kept in the sealed bag provided and that parts be used as soon as possible when removed from bags



Tape and Reel Specifications



Symbol	Description	Dimensions in Millimeters					
Symbol	Description	0402 Size	0603, 0805, 1206 & 1210 Sizes				
A _o	Width of Cavity	Dependent on Chip Size to Minimize Rotation.					
B	Length of Cavity	Dependent on Chip	Size to Minimize Rotation.				
K _o	Depth of Cavity	Dependent on Chip	Size to Minimize Rotation.				
W	Width of Tape	8 -/+0.2	8 -/+0.3				
F	Distance Between Drive Hole Centers and Cavity Centers	3.5 -/+0.05	3.5 -/+0.05				
Е	Distance Between Drive Hole Centers and Tape Edge	1.75 -/+0.1	1.75 -/+0.1				
P ₁	Distance Between Cavity Centers	2-/+0.05	4 -/+0.1				
P ₂	Axial Drive Distance Between Drive Hole Centers & Cavity Centers	2 -/+0.1	2 -/+0.1				
Po	Axial Drive Distance Between Drive Hole Centers	4 -/+0.1	4 -/+0.1				
D	Drive Hole Diameter	1.55 -/+0.05	1.55 -/+0.05				
D ₁	Diameter of Cavity Piercing	N/A	1.05 -/+0.05				
T ₁	Top Tape Thickness	0.1 Max	0.1 Max				

Notes:

Conforms to EIA-481-1, Revision A

• Can be supplied to IEC publication 286-3

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at <u>www.littelfuse.com/disclaimer-electronics</u>.

